




**SPECIFICATION SHEET**

<b>SPECIFICATION SHEET NO.</b>	N1230- SMAFSS36000S36
<b>DATE</b>	Dec. 30, 2021
<b>REVISION</b>	A0
<b>DESCRIPTION</b>	SMD Schottky Barrier Rectifier, 2 Pads, SMAF series, SS36F Type Reverse Voltage 60V Max. Forward Current 3.0A Max. Operating Temp. Range -50°C ~+150°C Package in Tape/Reel, 3000pcs/Reel RoHS/RoHS III compliant
<b>CUSTOMER</b>	
<b>CUSTOMER PART NUMBER</b>	
<b>CROSS REF. PART NUMBER</b>	
<b>ORIGINAL PART NUMBER</b>	MDD SS36F
<b>PART CODE</b>	SMAFSS36000S36

<b>VENDOR APPROVE</b>			
Issued/Checked/Approved			
DATE: Dec. 30, 2021			

<b>CUSTOMER APPROVE</b>	
DATE:	

1/4/2022

## SMD SCHOTTKY BARRIER RECTIFIER SMAF SERIES

### MAIN FEATURE

- The plastic package carries Underwriters Laboratory Flammability Classification 94V-0
- Low power loss and high efficiency
- Built-in strain relief,
- High forward surge current capability
- Metal silicon junction, majority carrier conduction
- High temperature soldering guaranteed: 260°C/ 10 seconds at terminals



### APPLICATION

- For surface mounted applications

**RFQ**

[Request For Quotation](#)

### PART CODE GUIDE

SMAF	SS36000	S	36
1	2	3	4

- 1) **SMAF**: SMD Schottky Barrier Rectifier, 2 Pads, SMAF series,
- 2) **SS36000**: Type code for original part number SS36
- 3) **S**: Package code, Tape/reel, 5000pcs/reel.
- 4) **36**: Specification code for. Forward Current 3.0A Max, Reverse Voltage 60V Max.

**SMD SCHOTTKY BARRIER RECTIFIER SMAF SERIES**

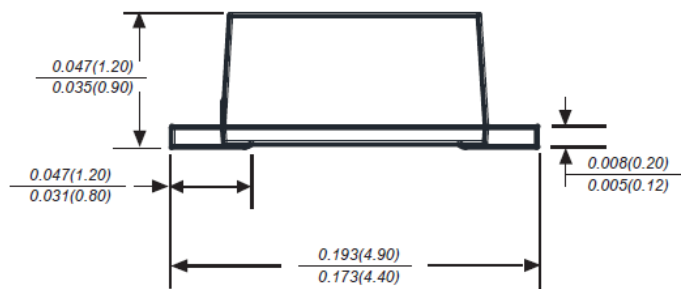
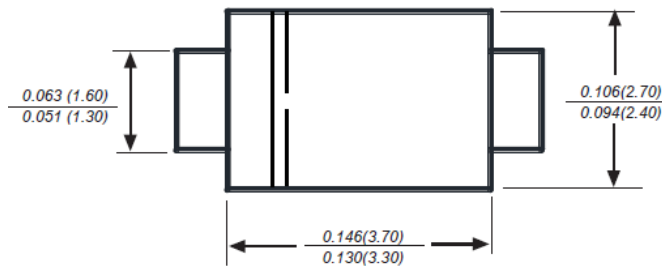
**DIMENSION (Unit: Inch/mm)**

Image for reference

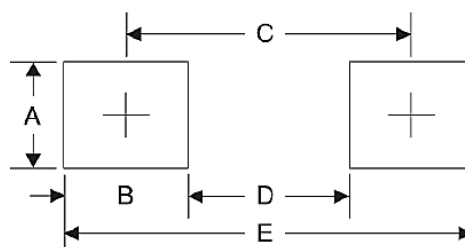


Marking: SS36F

SMAF



Recommend Pad Layout



Symbol	Unit (Inch)	Unit (mm)
A	0.071	1.80
B	0.063	1.60
C	0.150	3.80
D	0.087	2.21
E	0.213	5.40

**SMD SCHOTTKY BARRIER RECTIFIER SMAF SERIES**
**MECHANICAL DATA**

Case	Terminals	Polarity	Mounting Position	Weight per piece
JEDEC SMAF molded plastic body	Solder plated, Solderable per MIL-STD-750, Method 2026	Color band denotes cathode end	Any	0.00095 Ounce, 0.0270 grams

**MAX. RATING & CHARACTERISTICS**

Parameter	SYMBOLS	VALUE			UNITS
		Min.	Typical	Max.	
Repetitive peak reverse voltage	V <sub>RRM</sub>			60	Volts
RMS voltage	V <sub>RMS</sub>			42	Volts
DC blocking voltage	V <sub>DC</sub>			60	Volts
Average forward output rectified current at TL(see fig.1)	I <sub>AV</sub>			3.0	A
Peak forward surge current 8.3ms single half sine-wave superimposed on rated load (JEDEC Method)	I <sub>FSM</sub>		80		A
Instantaneous forward voltage at 3.0A	V <sub>F</sub>			0.70	Volts
DC reverse current at rated DC blocking voltage	I <sub>R</sub>	TA=25°C		0.50	mA
		TA=100°C		3.0	mA
Junction capacitance (Note 2)	C <sub>J</sub>		180		pF
Thermal resistance (Note 3)	R <sub>θJA</sub>		70		°C/W
	R <sub>θJC</sub>		18		
Operating junction temperature range	T <sub>J</sub>	-55		+150	°C
Storage temperature range	T <sub>STG</sub>	-55		+150	°C

Note

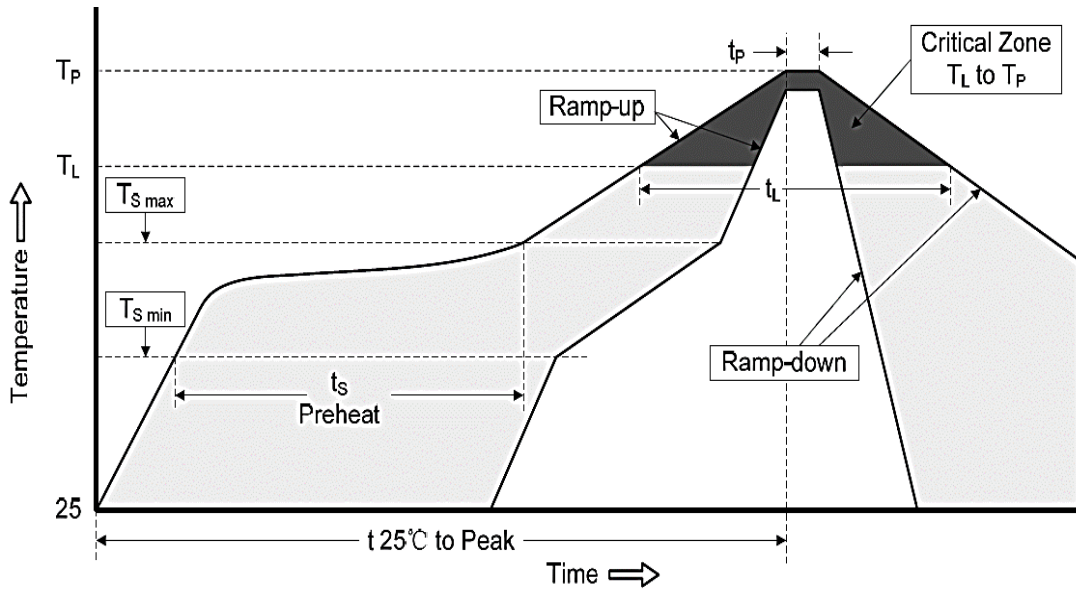
1. Ratings at 25 C ambient temperature unless otherwise specified. Single phase half-wave 60Hz, resistive or inductive load, for capacitive load current derate by 20%.
2. Measured at 1.0MHz and applied reverse voltage of 4.0Voltage
3. P.C.B. mounted with 0.2x0.2”(5.0x5.0mm) copper pad areas.

**SMD SCHOTTKY BARRIER RECTIFIER SMAF SERIES**
**RELIABILITY**

Number	Experiment Items	Experiment Method And Conditions	Reference Documents
1	Solder Resistance Test	Test 260°C± 5°C for 10 ± 2 sec. Immerse body into solder 1/16" ± 1/32"	MIL-STD-750D METHOD-2031.2
2	Solderability Test	230°C ±5°C for 5 sec.	MIL-STD-750D METHOD-2026.1 0
3	Pull Test	1 kg in axial lead direction for 10 sec.	MIL-STD-750D METHOD-2036.4
4	Bend Test	0.5Kg Weight Applied To Each Lead, Bending Arcs 90 °C ± 5 °C For 3 Times	MIL-STD-750D METHOD-2036.4
5	High Temperature Reverse Bias Test	TA=100°C for 1000 Hours at VR=80% Rated VR	MIL-STD-750D METHOD-1038.4
6	Forward Operation Life Test	TA=25°C Rated Average Rectified Current	MIL-STD-750D METHOD-1027.3
7	Intermittent Operation Life Test	On state: 5 min with rated IRMS Power Off state: 5 min with Cool Forced Air. On and off for 1000 cycles.	MIL-STD-750D METHOD-1036.3
8	Pressure Cooker Test	15 PSIG, TA=121°C, 4 hours	MIL-S-19500 APPENOIXC
9	Temperature Cycling Test	-55°C~+125°C; 30 Minutes For Dwelled Time 5 minutes for transferred time. Total: 10 cycles.	MIL-STD-750D METHOD-1051.7
10	Thermal Shock Test	0°C for 5 minutes., 100°C for 5minutes, Total: 10 cycles	MIL-STD-750D METHOD-1056.7
11	Forward Surge Test	8.3ms Single Sale Sine-wave One Surge.	MIL-STD-750D METHOD-4066.4
12	Humidity Test	TA=65°C, RH=98% for 1000 hours.	MIL-STD-750D METHOD-1021.3
13	High Temperature Storage life Test	150°C for 1000 Hours	MIL-STD-750D METHOD-1031.5

**SMD SCHOTTKY BARRIER RECTIFIER SMAF SERIES**

**SUGGESTED REFLOW PROFILE (For Reference Only)**



<b>Profile Feature</b>		Pb-Free Assembly
<b>Average Ramp-up Rate (Ts Max to Tp)</b>		3°C/second Max
<b>Preheat</b>	<b>Temperature Min (Ts Min.)</b>	150°C
	<b>Temperature Max (Ts Max.)</b>	200°C
	<b>Time (ts Min. to ts Max.)</b>	60 ~ 180 seconds
<b>Time maintained above</b>	<b>Temperature (Tl)</b>	217°C
	<b>Time (tl)</b>	60 ~ 150 seconds
<b>Peak/Classification Temperature (Tp)</b>		260 °C
<b>Time within 5°C of actual Peak Temperature (tp)</b>		10 seconds
<b>Ramp-down rate</b>		6 °C /Second Max.
<b>Time 25 °C to Peak Temperature</b>		6 minutes Max.
<b>Suggest reflow times</b>		3 Times Max.

**SMD SCHOTTKY BARRIER RECTIFIER SMAF SERIES**

**RATINGS AND CHARACTERISTIC CURVES (For Reference Only)**

Fig.1 Forward Current Derating Curve

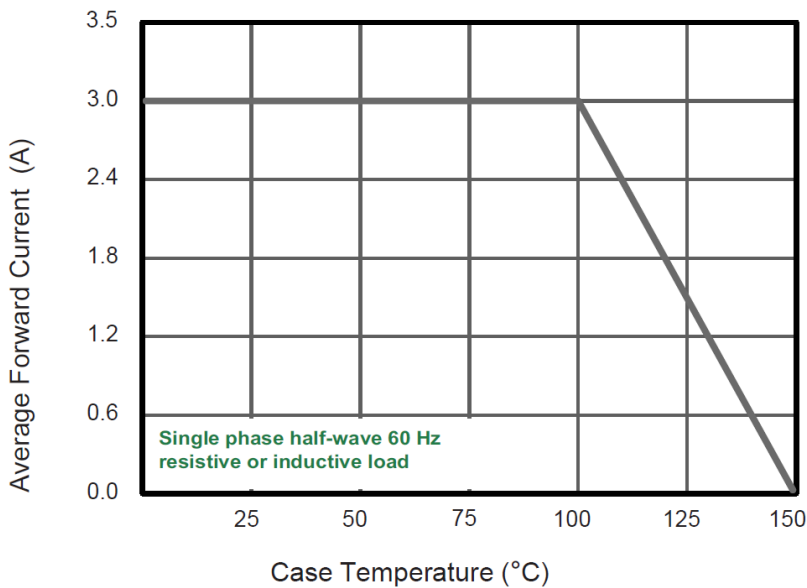
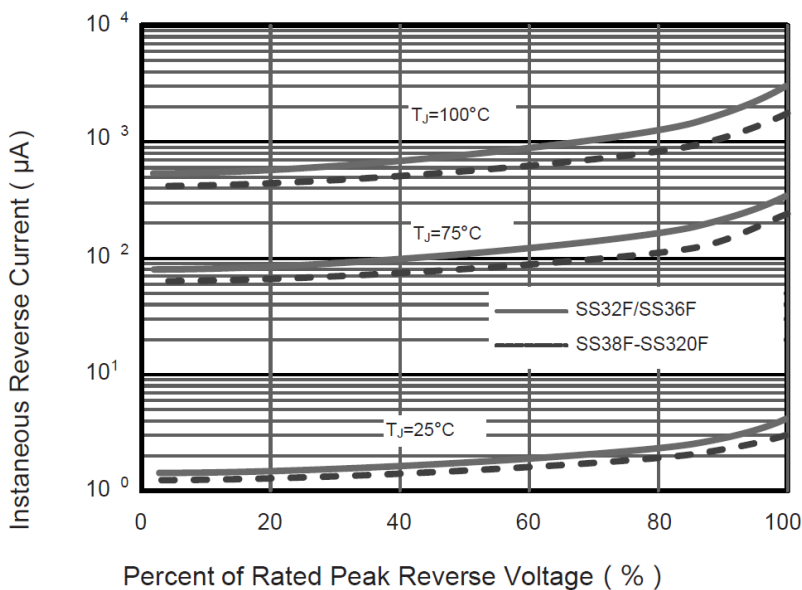


Fig.2 Typical Reverse Characteristics



**SMD SCHOTTKY BARRIER RECTIFIER SMAF SERIES**

**RATINGS AND CHARACTERISTIC CURVES (For Reference Only)**

Fig.3 Typical Forward Characteristic

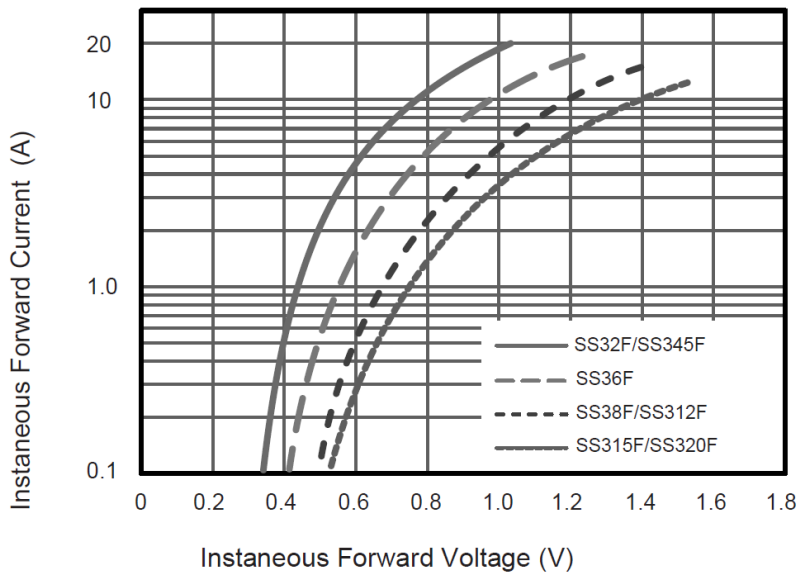
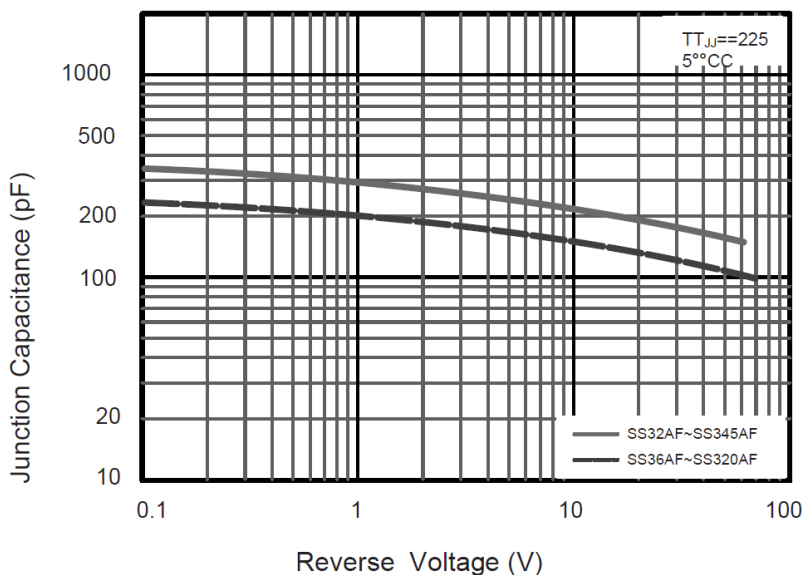


Fig.4 Typical Junction Capacitance

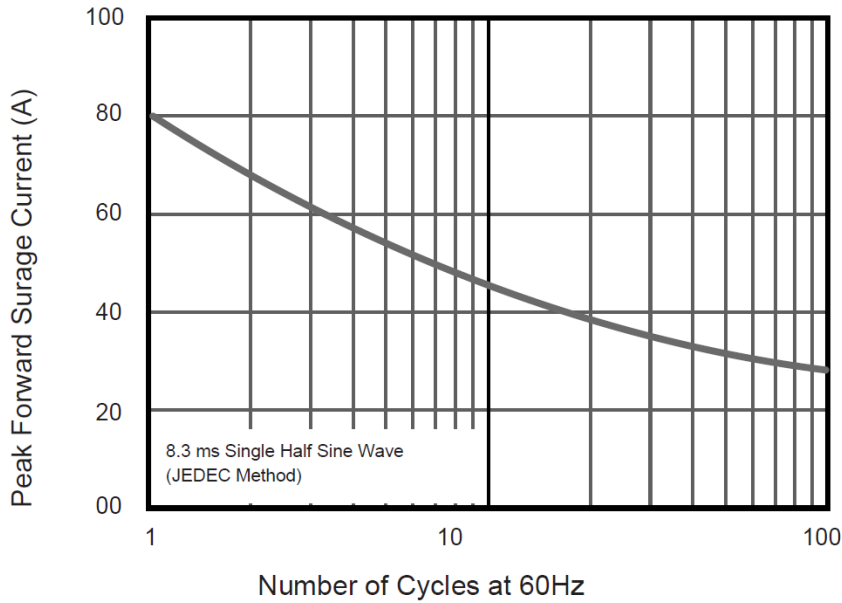




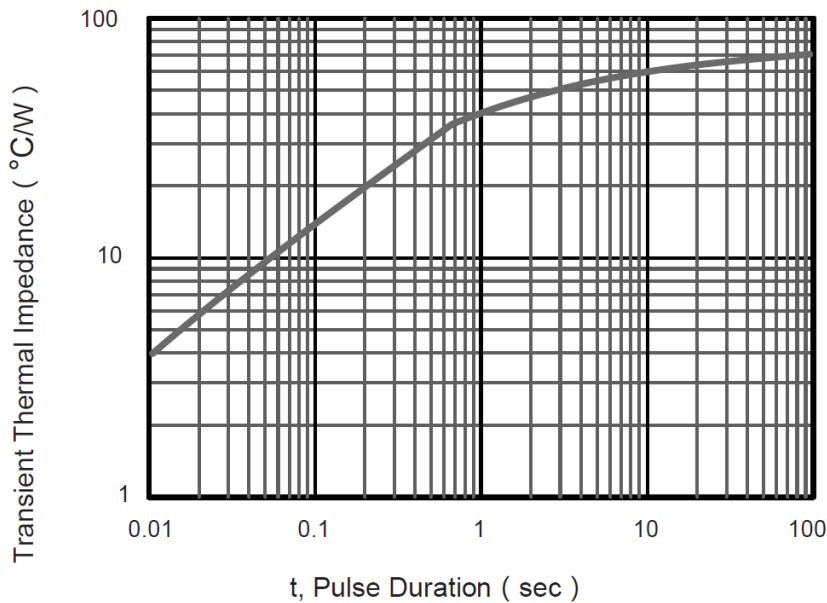
**SMD SCHOTTKY BARRIER RECTIFIER SMAF SERIES**

**RATINGS AND CHARACTERISTIC CURVES (For Reference Only)**

**Fig.5 Maximum Non-Repetitive Peak Forward Surge Current**



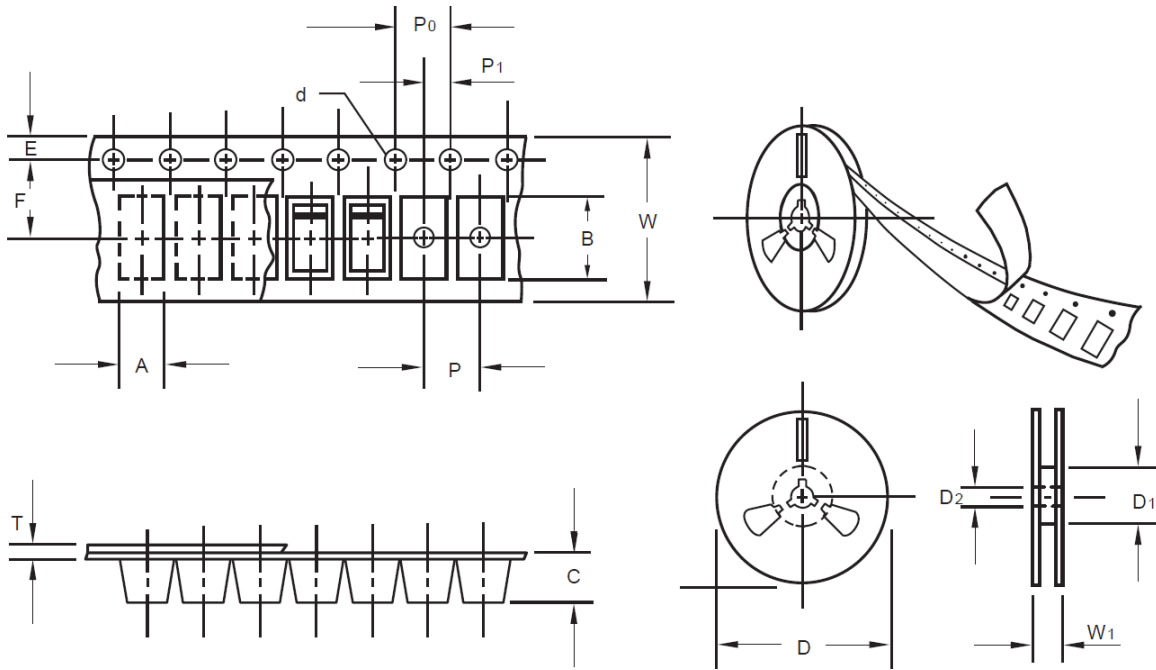
**Fig.5- Typical Transient Thermal Impedance**



**SMD SCHOTTKY BARRIER RECTIFIER SMAF SERIES**

**TAPE/REEL (Unit: mm)**

All Devices are packed in accordance with EIA standard RS-481-A and specifications.



Item	Symbol	Tolerance	SMAF
Carrier width	A	0.1	2.80
Carrier Length	B	0.1	4.75
Carrier Depth	C	0.1	1.42
Sprocket hole	d	0.05	1.50
7"Reel outside diameter	D	2.0	178.00
7"Reel inner diameter	D1	Min.	54.40
Feed hole diameter	D2	0.5	13.00
Sprocket hole position	E	0.1	1.75
Punch hole position	F	0.1	5.05
Punch hole pitch	P	0.1	4.00
Sprocket hole pitch	P0	0.1	4.00
Embossment center	P1	0.1	2.00
Overall tape thickness	T	0.1	0.30
Tape width	W	0.3	8.00
Reel width	W1	1.0	12.30

**SMD SCHOTTKY BARRIER RECTIFIER SMAF SERIES**

**PACKAGE For Reference**

Case Code	SMAF
Reel Size	7"
Reel Size	178 mm
MPQ/Reel	3000 pcs
Qty. /Box	6000 pcs
G.W/Box	1 lbs

**DISCLAIMER**

NextGen Component, Inc. reserves the right to make changes to the product(s) and or information contained herein without notice. No liability is assumed as a result of their use or application. No rights under any patent accompany the sale of any such product(s) or information